

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	3450	(conductive adj2 (adhesive paste paint ink) (hole via) adj2 fill adj2 paste) and (copper Cu silver Ag Pd palladium metal alloy) near5 (powder particle) and (particle grain) near2 (size diameter micron) and (wt weight vol volume mass) near2 ('%' \$2% percent ratio part) and (resin binder epoxy (alkyd phenol thermoset\$5 epoxy) near5 resin epi\$2ote)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/09 15:52
S2	891	S1 and (primary particle) and (agglomerat\$4 floc aggregate cluster unimodal)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/09 15:53
S3	60	S1 and (copper Cu silver Ag Pd palladium metal alloy) with (wet adj2 reduction reduction near5 solution)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/09 15:55
S4	232	S1 and (powder particle slurry) with (jet adj mill dry adj2 grinding air adj classifier turbo adj classifier colli\$5 near5 dispersion high adj pressure homogeni\$2er)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/09 15:56
S5	225	(S2 S3 S4) and (252/500,512,513,514.ccls. 75/255.ccls. 428/356, 355ep,357,402,404.ccls. 156/306.3.ccls. 361/748.ccls. 427/97.2, 97.3,97.7.ccls. 213/13,311,319.ccls.)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/09 15:56
S6	365	S1 and ((liquid adj2 epoxy alicyclic adj epoxy glycidyl adj amine glycidyl adj ester epi\$2ote)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/09 15:57
S7	19	S1 and dimer\$3 with (ether ester\$7) with (\$3glycidyl epoxy) and amine same (adduct curing harden\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/09 15:59
S8	337	S1 and (particle powder) near5 (surface coat\$4 plat\$4) with alloy	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/09 16:01
S9	365	(S2 S3 S4) and viscosity near5 (\$7poise \$7pascal pa\$2 mpa\$2 cps low)	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/09 16:02
S10	33	conductive adj2 (adhesive paste paint ink) and (copper Cu silver Ag metal alloy) and (particle grain) near5 (size diameter micron) and (primary particle) and (agglomerat\$4 floc aggregat\$4)	FPRS; EPO; JPO; DERWENT	OR	ON	2007/05/09 16:03
S11	15	conductive adj2 (adhesive ink paint paste).clm. and (copper Cu silver Ag metal alloy).clm. and (powder particle primary).clm. and (agglomerat\$4 aggregate floc).clm. and (dimeric \$3glycidyl epoxy resin binder).clm.	US-PGPUB; USPAT; USOCR	OR	ON	2007/05/09 16:03
S12	40	((yuichiro near2 sugita toshiaki near2 takenaka).in. matsushita.as.) and (copper silver metal alloy) and (primary particle) and (agglomerat\$5 floc aggregate) and (conductive via adj fill hole adj fill) near5 (adhesive paste)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2007/05/09 16:03
S13	37	("06262375" "07176846" "08279665" "2000297303" "2002332501" "2002343135" "2003092024" "2003141929" "2003268402" "2004047856" "6479763" "6494931" "20030122257" "20010005545" "5551626").did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/05/09 16:04